

Modification Spec details ESCC5711/002 issue04

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After checking the <u>ESCC5711_002_Dec2018-iss4_CapaMOS</u> we noticed since iss03, there is an error of dimensions (we think a mistake of copy/paste) p11 and 12. The iss 002 is compliant

P11 : dimensions A and D are not ok on issue 003and 004, ok issue 002

P12 : dimensions: A,D, F is not ok on issue 003 and 004, ok issue 002

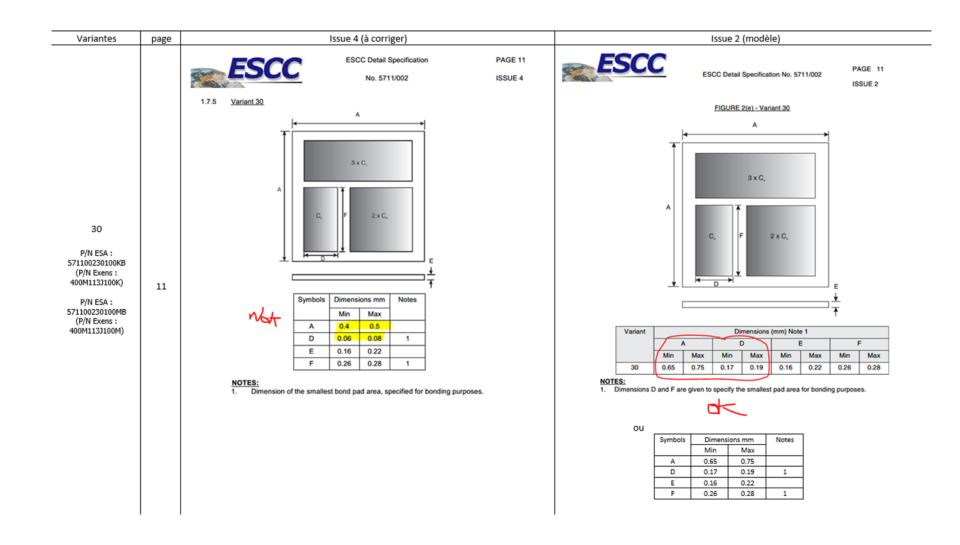
See below more details

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Modules & Systems Activity

Summary





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Summary





P/N ESA: 571100231100KB (P/N Exens:

P/N ESA: 571100231100MB (P/N Exens: 400M114J100M)

2 x C. 31 400M114J100K) 12 Symbols Dimensions mm Max

Dimension of the smallest bond pad area, specified for bonding purposes.

0.4

0.06

0.16

0.26

D

Ε

0.5

0.08

0.22

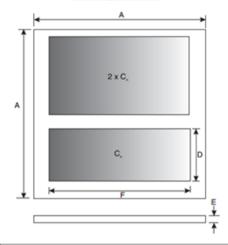
0.28

1

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FIGURE 2(f) - Variant 31



Variant	Dimensions (mm) Note 1								
A		A	D		E		F		
	Min	Max	Min	Max	Min	Max	Min	Max	
31	0.45	0.55	0.1	0.12	0.16	0.22	0.89	0.41	

1. Dimension D and F are given to specify the smallest pad area for bonding purposes.



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	Symbols	Dimens	Notes	
-		Min	Max	
[Α	0.45	0.55	
	D	0.1	0.12	1
	Ε	0.16	0.22	
	F	0.89	0.41	1

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Thank you for your attention



